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Docket No.: M-9433 US

November 15, 2001

Box Patent Application
Commissioner For Patents
Washington, D. C. 20231

Enclosed herewith for filing is a patent application, as follows:

Inventor: Adrian E. Ong
Title: Layout and Use of Bond Pads and Probe Pads for Testing of Integrated Circuits Devices

☒ Return Receipt Postcard
☒ This Transmittal Letter (in duplicate)
14 pages Specification (not including claims)
7 pages Claims
1 page Abstract
9 Sheets of Drawings (Figs. 1, 2, 3, 4, 5, 6, 7, 8, and 9)
2 pages Declaration For Patent Application and Power of Attorney
1 page NonPublication Request
1 page Information Disclosure Statement
1 page PTO Form 1449 citing 2 references
☒ Copies of 2 Cited References submitted

☒ Applicant(s) assert(s) entitlement to small entity status for the attached patent application**CLAIMS AS FILED (fees computed under 37 CFR §1.9(f))**

| For | Number Filed | | Number Extra | | Rate | | Basic Fee |
|---|-----------------|-------|-----------------|---|---------|---|-----------|
| Total Claims | 38 | -20 = | 18 | x | \$ 9.00 | = | \$ 162.00 |
| Independent Claims | 7 | -3 = | 4 | x | \$42.00 | = | \$ 168.00 |
| <input type="checkbox"/> Fee of _____ for the first filing of one or more multiple dependent claims per application | | | | | | | \$ |
| <input type="checkbox"/> Fee for Request for Extension of Time | | | | | | | \$ |

Please make the following charges to Deposit Account 19-2386:

- ☒ Total fee for filing the patent application in the amount of \$ 700.00
☒ The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account 19-2386.

EXPRESS MAIL LABEL NO:
EL 707 911 005 US

Respectfully submitted,


Peter G. Mikhail
Reg. No. 46,930J1046 U.S. PTO
10/003375
11/15/01

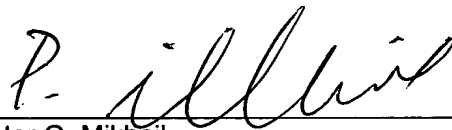
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MODIFIED PTO/SB/35 (11-00)

| | | |
|--|--------------------|--|
| REQUEST AND CERTIFICATION UNDER 35 U.S.C. 122(b)(2)(B)(i) | Inventor | Adrian E. Ong |
| | Title | Layout and Use of Bond Pads and Probe Pads for Testing of Integrated Circuits Devices |
| | Atty Docket Number | M-9433 US |

I hereby certify that the invention disclosed in the attached application **has not and will not be** the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

November 15, 2001
Date


Peter G. Mikhail
Reg. No.: 46,930

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant **must** notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. **Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).**